

# A CHECK-VALVED SILICONE DIAPHRAGM PUMP

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## ABSTRACT

Two generations of check-valved silicone rubber diaphragm pumps are presented. Significant improvements have been made from pump to pump including the design and fabrication of a double-sided check valve, a bossed silicone membrane, and silicone gaskets. Water flow rates of up to 13 ml/min and a maximum back pressure of 5.9 kPa were achieved through pneumatic operation with an external compressed air source. Using a custom designed solenoid actuator, flow rates of up to 4.5 ml/min and a maximum back pressure of 2.1 kPa have been demonstrated.

## INTRODUCTION

A reciprocating diaphragm with two passive check valves is a common micropump scheme [1-3]. Other schemes include diffuser [4, 5], electrohydrodynamic [6, 7], rotary [8], and gear pumps [9]. In diaphragm pumps, fluidic transport is achieved by alternating the production of under- and over-pressures in the pump chamber, resulting in a supply mode and a pump mode, respectively. During these modes, pumping occurs only when enough pressure difference is produced to overcome the cracking pressure of the rectifying valves. Since microactuators are limited by a small stroke capability, low cracking pressure, reverse leakage, and flow resistance are highly desirable characteristics in check valves.

Previously, Shoji et al [10] and Smith and Hök [11] demonstrated valves designed for use with micropumps, however, both exhibited some degree of reverse leakage and had a limited flow rate. Parylene check valves modified from [12] satisfied the above requirements with the additional advantage of negligible stiction and surface tension effects. The geometric configuration of the moving membrane element of the check valve, in addition to the low Young's modulus of Parylene (~2.8 GPa), resulted in high deflections and, thus, negligible flow resistance. In fact, the flow resistance characteristics of the check valve were nearly identical to those of a plain orifice. Pumps designed with these valves were capable of reverse blocking even in the neutral state unlike valveless pumps [4-7].

It is also necessary to minimize the pressure required to deflect the pumping membrane. Since only weak forces are available, a membrane material with low Young's modulus is ideal. Silicone rubber (MRTV1; American Safety Technologies, Inc.) has a low Young's modulus

and was implemented as a membrane material in microvalves [13] and micropumps [14] due to its high elongation (100-1000%). Thus, large deflections and efficient use of pump chamber volume are realized. Silicone rubber (Sylgard 184; Dow Corning) was also used in this pump to create molded gaskets.

The testing apparatus involved the use of Plexiglas pump seats in addition to a combination of gluing and clamping. Actuation was supplied by a custom designed solenoid. For the second generation pump, pneumatic operation with a pressurized air source controlled by a three-way solenoid valve was also examined.

## DESIGN AND FABRICATION

The first generation pump was assembled by gluing chips together (Fig. 1). As this made it difficult to assemble and repair, the second generation (Fig. 2) was

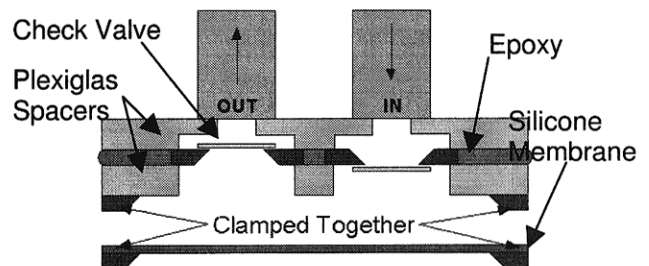


Figure 1: 2D Cross Section of 1st Generation Pump

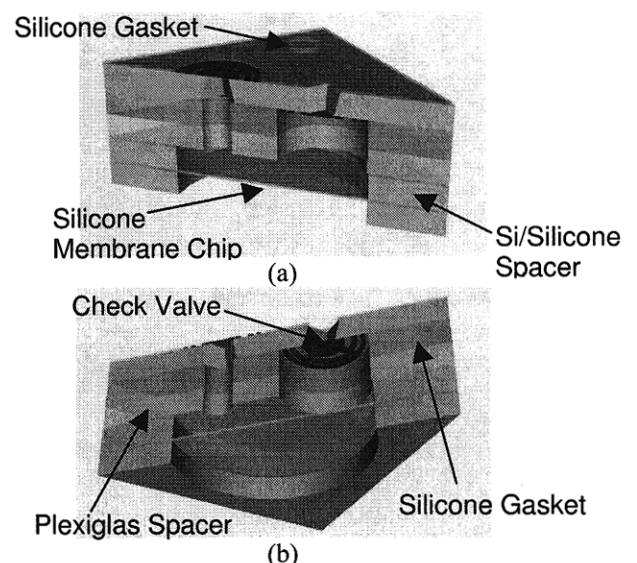


Figure 2: (a) & (b) 3D Cross Sections of 2nd Generation Pump

designed to eliminate the need for glue by taking advantage of the sealing property of silicone rubbers. Alternating layers of silicone and silicon allowed the pump to be watertight when clamped.

### Parylene Check Valve

In the first pump, check valves were fabricated on the same side of the wafer and thus only able to rectify flow in one direction. Pump assembly was complicated by having to dice individual valves and glue them, facing in opposite directions, to a Plexiglas structural support. As a result, the second generation pump check valves were made with a double-sided process shown in Fig. 3.

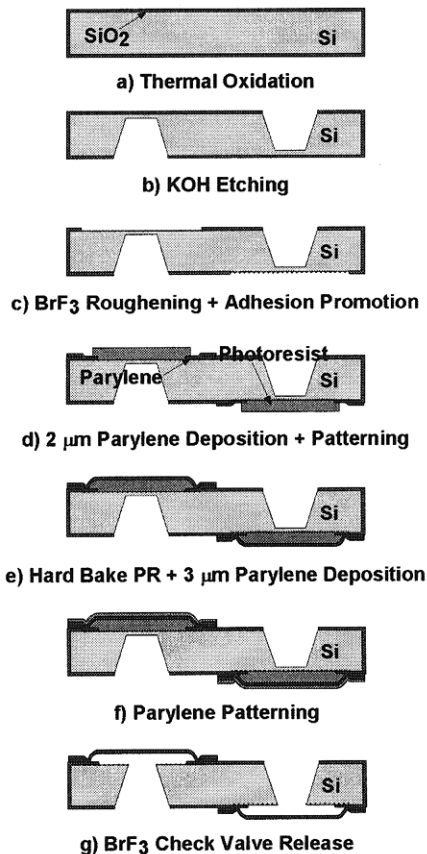


Figure 3: Double-Sided Check Valve Process Flow

The fabrication process started with a thermally oxidized (1.5  $\mu\text{m}$  thick) silicon wafer. Cavities that would eventually become orifices were defined using a KOH etch. 20  $\mu\text{m}$  of silicon was left to serve as a structural support. A circular region of silicon was exposed and roughened using  $\text{BrF}_3$  gas phase etching. This reduced stiction of the Parylene tethers to the substrate and enhanced adhesion of the anchors. A-174 adhesion promoter was applied followed by the deposition of a 2  $\mu\text{m}$  layer of Parylene-C. The Parylene was patterned in an oxygen plasma and then a sacrificial photoresist layer (5  $\mu\text{m}$  of AZ 4400) was spun and patterned. To prevent check valve failure due

to sharp corners in the Parylene, the photoresist was hard baked to round off the convex corners. A second layer of Parylene (3  $\mu\text{m}$ ) was then deposited and masked with 1000  $\text{\AA}$  of aluminum during patterning in oxygen plasma. This Al masking layer was replaced with thick photoresist (10  $\mu\text{m}$  of AZ 4620) in the double-sided process to avoid overheating the photoresist and Parylene layers during thermal evaporation. To release the check valve, the 20  $\mu\text{m}$  silicon layer obstructing the orifice was etched away in  $\text{BrF}_3$ . After dicing, the Al masking layer and sacrificial photoresist layer were removed to complete the fabrication process. Top views of the check valves used

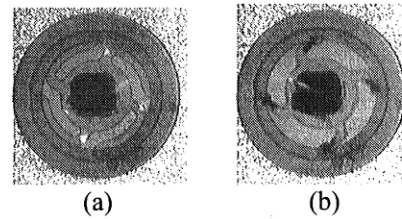


Figure 4: Check Valves (a) at Rest & (b) Deflected by Applied Pressure are shown in Figure 4.

### Silicone Membrane

To efficiently use pump chamber volume, it was necessary to match the chamber geometry with that of the membrane. A large orifice etched into silicon formed a spacer chip that defined the pump chamber when situated between the check valves and pumping membrane. First generation KOH etched silicon membranes (7  $\times$  7  $\text{mm}^2$ ) and spacers were square making high compression ratios difficult to achieve. By using DRIE, a cylindrical pump chamber and matching circular diaphragm (8 mm in diameter) could be realized. In addition, it was easier to define cylindrical boss structures without the need for corner compensation.

20  $\mu\text{m}$  silicon membranes are formed via KOH or DRIE etching. Silicone rubber is spin coated to a thickness of 80  $\mu\text{m}$  (first generation) and 140  $\mu\text{m}$  (second generation). An  $\text{SF}_6$  plasma is used to release the

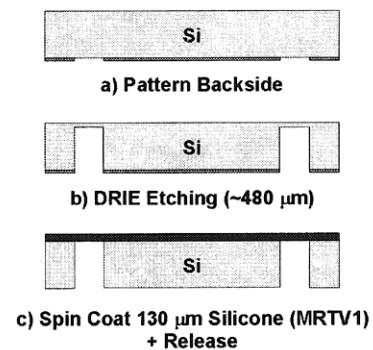


Figure 6: Bossed Silicone Membrane Process Flow

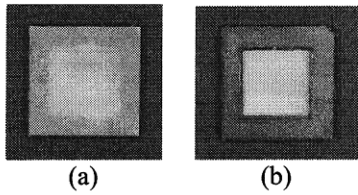


Figure 7: KOH Etched Silicone Membrane

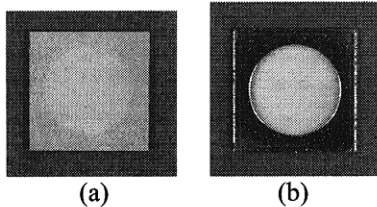


Figure 8: DRIE Etched Silicone Membrane

membranes. The fabrication process and various membrane designs are shown in Figures 6-8. The first generation spacer is simply an  $8 \times 8 \text{ mm}^2$  orifice etched into silicon via KOH. Second generation spacers are formed by removing the membrane portion of the membrane chips. The silicone on the surrounding areas is left as a means to seal the structure during assembly.

#### Silicone Gasket

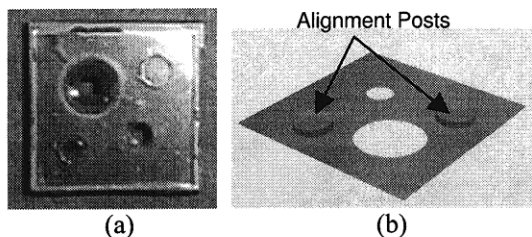


Figure 9: (a) Gasket on Check Valve Chip & (b) 3D View of Gasket

Molded silicone gaskets were introduced in the second pump to seal the check valves to the pump seat (Fig. 9). To prevent silicone membranes from adhering to the Parylene check valves during pump operation, it was necessary to insert a machined Plexiglas spacer. However, this created the need for another silicone gasket to seal the spacer to the check valve chip (Fig. 10).

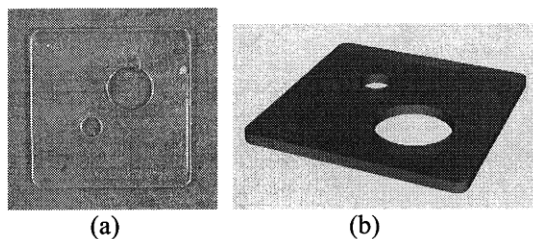


Figure 10: (a) Gasket & (b) 3D View of Gasket

Molding silicone into a DRIE etched silicon master (Fig.11) formed the gasket shown in Figure 9. 10  $\mu\text{m}$

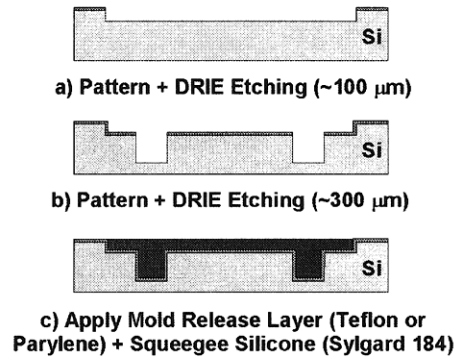


Figure 11: Silicon Gasket Process Flow

of photoresist (AZ 4620) was used as a mask for both etching steps. The first etch established the thickness of the gasket ( $\sim 100 \mu\text{m}$ ), and the second produced pits to form alignment pegs ( $400 \mu\text{m}$ ). These pegs mated with pits in a Plexiglas pump seat. A layer of Parylene or plasma deposited Teflon ( $\text{CHF}_3$ ) can be used as mold release layers. The remaining gaskets were molded from precision milled Delrin masters.

#### Packaging

The first generation pump was assembled through a combination of clamping and gluing. The membrane chip was glued to a Plexiglas plate and clamped to the rest of the pump which consisted of chips stacked and glued together. Tygon tubing was connected to the input and output to facilitate testing. A solenoid actuator was then properly positioned beneath the membrane.

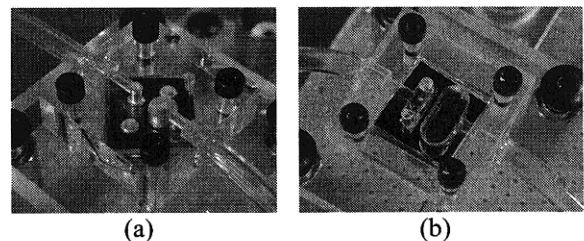


Figure 13: Top View of (a) Single Inlet/Outlet & (b) Check Valve Array Pump

The second generation pump (Fig. 13) was entirely clamped and only required adhesive to connect the tubing and actuator to the packaging. This modular design allowed easy access to and replacement of individual components. Two different pump seats were precision milled from Plexiglas for the two different check valve configurations. Plexiglas backing plates allowed the pump to be clamped together and provided a means for attaching the actuator. A different backing plate was used during pneumatic testing.

## TESTING AND RESULTS

### Check Valve

Performance of the new check valves was characterized for both air and water (Fig. 14). Flow rate versus applied pressure plots with the check valve in place and removed (orifice only) are displayed together. As shown in [12], the twist-up tether configuration of the check valves allowed for enough deflection to achieve nearly atmospheric pressure at the exit. Check valve cracking pressures were below sensor resolution.

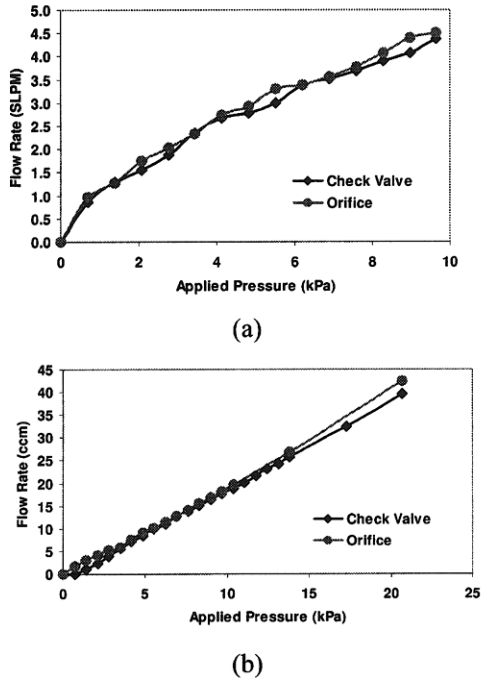


Figure 14: Flow Rate vs. Applied Pressure Plots for (a) Air & (b) Water

A novel check valve array, consisting of an inlet and outlet each comprised of three individual check valves, was also characterized. Figure 15 shows the flow rate increase as the number of check valves was increased. Similar data for check valves used in the first generation pump, which have orifice dimensions  $780 \mu\text{m} \times 780 \mu\text{m}$ , was presented in [12]. A slight advantage in performance for water flow was observed in the array case. The orifice dimensions for the solitary input/outlet check valves were  $770 \mu\text{m} \times 770 \mu\text{m}$  and for the check valves in the array,  $370 \mu\text{m} \times 370 \mu\text{m}$ . Effective orifice areas were  $5.93 \times 10^{-3} \text{ mm}^2$  and  $4.11 \times 10^{-3} \text{ mm}^2$ , respectively. Thus, a check valve array was preferred over a single check valve design to maximize flow rates.

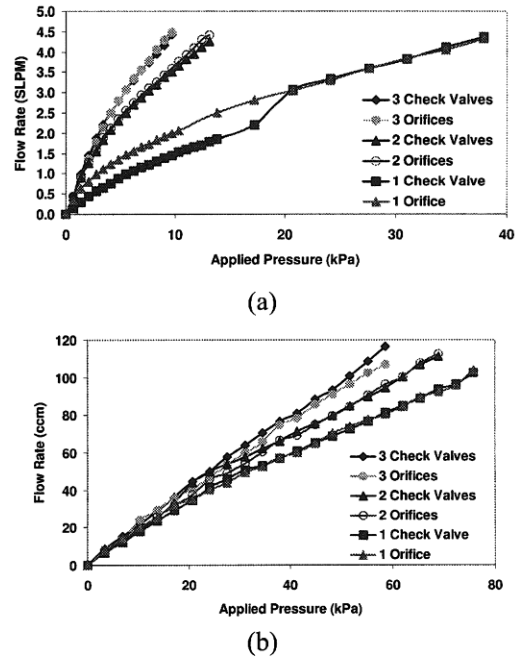


Figure 15: Flow Rate vs. Pressure in Check Valve Array for (a) Air & (b) Water

### Pump

#### 1<sup>st</sup> Generation

The solenoid actuator produced a reciprocating motion where an integrated plunger was retracted and extended

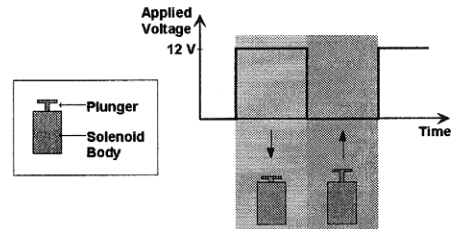
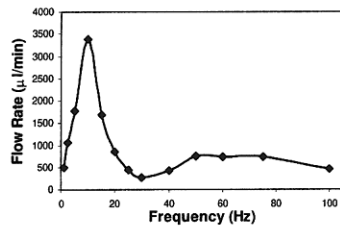
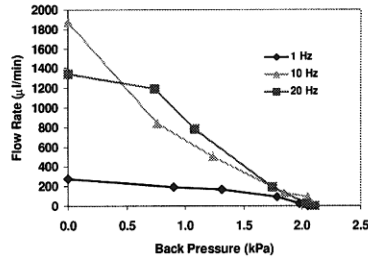


Figure 16: Solenoid Actuation Scheme

as current was turned on and off, respectively (Fig. 16). By using the plunger to deflect the silicone membrane repeatedly, water pumping was achieved. Flow rate versus frequency and back pressure plots are displayed in Figure 17. Careful priming was necessary to achieve optimal performance. As expected, flow rate was highly dependent on actuation frequency and was approximately linear for low frequencies. However, above 10 Hz, this linear relationship was lost as the membrane was unable to match actuator movement. The maximum achievable flow rate was  $3.4 \mu\text{l}/\text{min}$  at 10 Hz and maximum sustainable back pressure was 2.1 kPa which occurs for both 10 and 20 Hz.



(a)

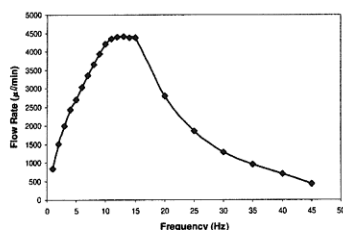


(b)

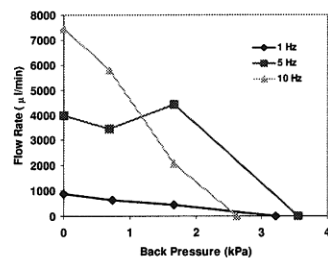
Figure 17: 1st Generation Pump (a) Flow Rate vs. Frequency & (b) Back Pressure Plots

## 2<sup>nd</sup> Generation: Pneumatic Pumping

Pneumatic operation was performed to verify the design of the second generation pump. Both check valve schemes were tested using an inflation pressure of 6.9 kPa and the results are shown in Figures 18 and 19. Up to 4.4 µl/min at 13 Hz and a back pressure of 3.6 kPa at 5 Hz were possible with the single inlet and outlet design. A nearly threefold increase in flow rate of 13 µl/min at 11 Hz and maximum back pressure of 5.9 kPa at 5 Hz was achieved in the array pump. Thus, the check valve array pump outperformed the single check valve pump in both categories. The same nonlinear behavior in the flow rate dependency on frequency was also observed, occurring for the same reasons as before.

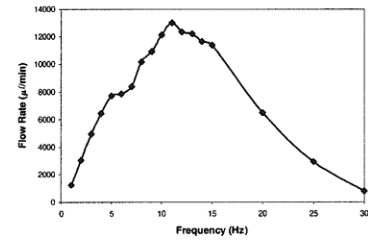


(a)

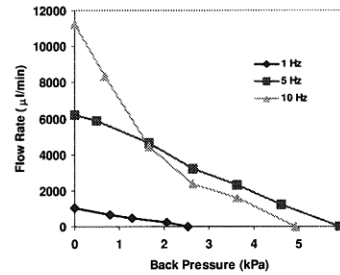


(b)

Figure 18: 2nd Generation Pump with Single Check Valve (a) Flow Rate vs. Frequency & (b) Back Pressure Plots for Pneumatic Actuation



(a)

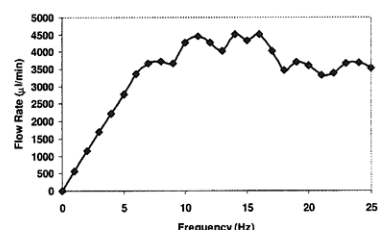


(b)

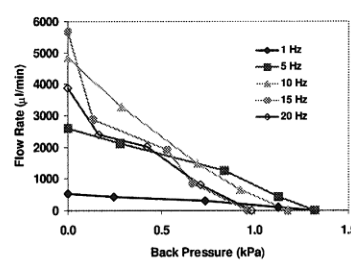
Figure 19: 2nd Generation Pump with Check Valve Array (a) Flow Rate vs. Frequency & (b) Back Pressure Plots for Pneumatic Actuation

## 2<sup>nd</sup> Generation: Solenoid Actuated Pumping

To eliminate the fall off in flow rate at high frequencies, it was necessary to physically connect the actuator to the pumping membrane. Thus, a new membrane with a circular silicon boss structure was implemented. This allowed the plunger of the actuator to be attached to the pump chamber via a silicon boss on the silicone membrane. The improvement in flow rate versus frequency performance for the single inlet/outlet pump is shown in Fig. 20. A maximum flow rate of 4.5 µl/min at 14 Hz was possible. However, the maximum back pressure decreased slightly to 1.32 kPa at 1 and 5 Hz.



(a)



(b)

Figure 20: Solenoid Actuated Pump (a) Flow Rate vs. Frequency & (b) Back Pressure Plots

## DISCUSSION

In an ideal situation, the volume of liquid pumped per actuation cycle is a constant regardless of the actuation frequency. However, as can be seen in Figures 21a-d,

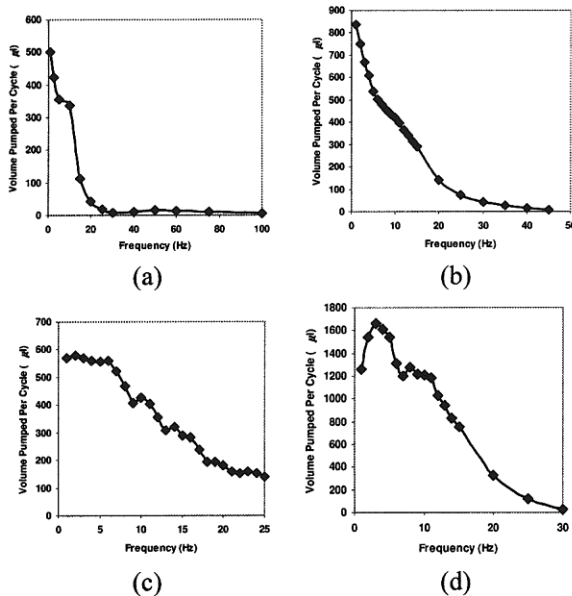


Figure 21: Volume Pumped Per Cycle vs. Frequency for (a) 1st Generation Pump, 2nd Generation Pump Actuated (b) Pneumatically and (c) with a Solenoid, and (d) 2nd Generation Pump with Check Valve Array Actuated Pneumatically

the volume decreases with increasing frequency. In the pneumatically actuated pump, since flow rate is equal to the pressure drop over the fluidic resistance ( $Q = P/R$ ), the volume pumped per cycle is inversely proportional to the frequency. Solenoid actuation, in which the membrane and plunger are physically connected, produces a more complicated behavior that cannot be completely described by this simple analysis. The data suggests that the membrane deflection, which occurs in a finite amount of time, might be a contributing factor as it also decreases with increasing frequency.

Discrepancies between the maximum flow rate achieved for pneumatic versus solenoid actuation were due to the inability of the solenoid actuator to produce deflections equal to the height of the pump chamber. For the pumps presented, a solenoid actuator was sufficient to demonstrate the device however, integrated thermopneumatic or piezoelectric actuators are also being investigated.

## CONCLUSION

Two silicone diaphragm pumps are presented. Multiple check valve configurations were explored and a check valve array is optimal for pumping higher volumes. A greater reduction in dead volume and better actuator are necessary to achieve air pumping.

## ACKNOWLEDGMENTS

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